Kingbright

Part Number: PSC08-11EWA

High Efficiency Red

Features

- 0.8 inch character height.
- Low current operation.
- High contrast and light output.
- Common cathode and common anode available.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram
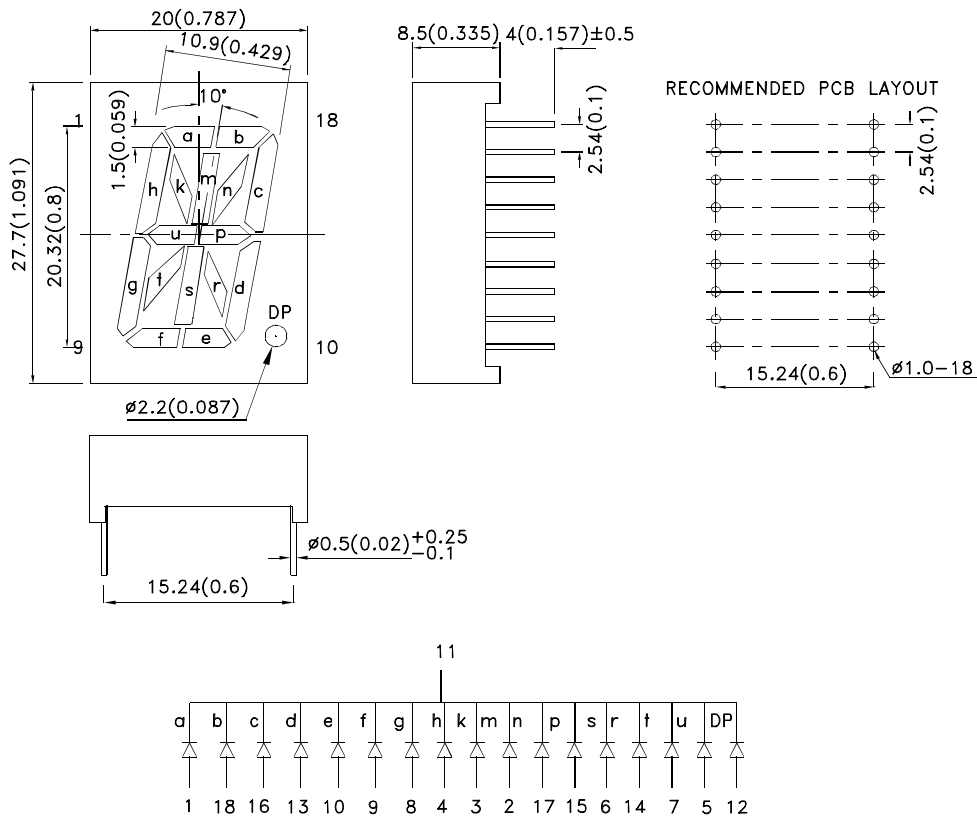
Notes:
1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
PSC08-11EWA	High Efficiency Red (GaAsP/GaP)	White Diffused	3600	7700	Common Cathode, Rt. Hand Decimal.
			*900	*2100	

Notes:
1. Luminous intensity/ luminous Flux: +/-15%.
   * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.		Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627	*627		nm	I_F=20mA
λD [1]	Dominant Wavelength	High Efficiency Red	625	*617		nm	I_F=20mA
$\Delta\lambda$1/2	Spectral Line Half-width	High Efficiency Red	45			nm	I_F=20mA
C	Capacitance	High Efficiency Red	15			pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	High Efficiency Red	2.0		2.5	V	I_F=20mA
I_R	Reverse Current	High Efficiency Red			10	uA	V_R=5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
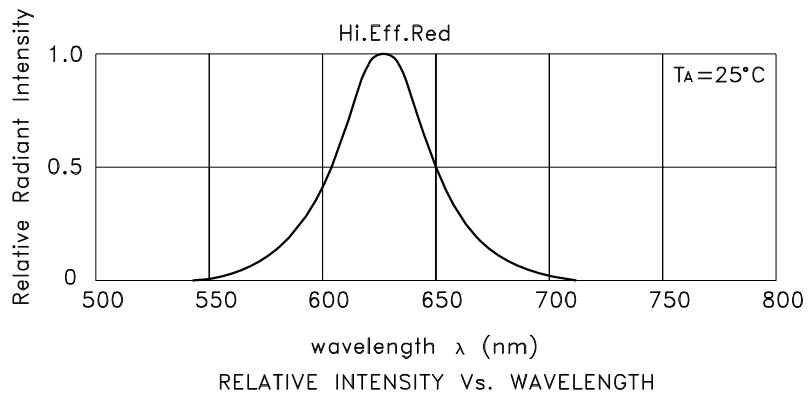* Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	160	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

Notes:
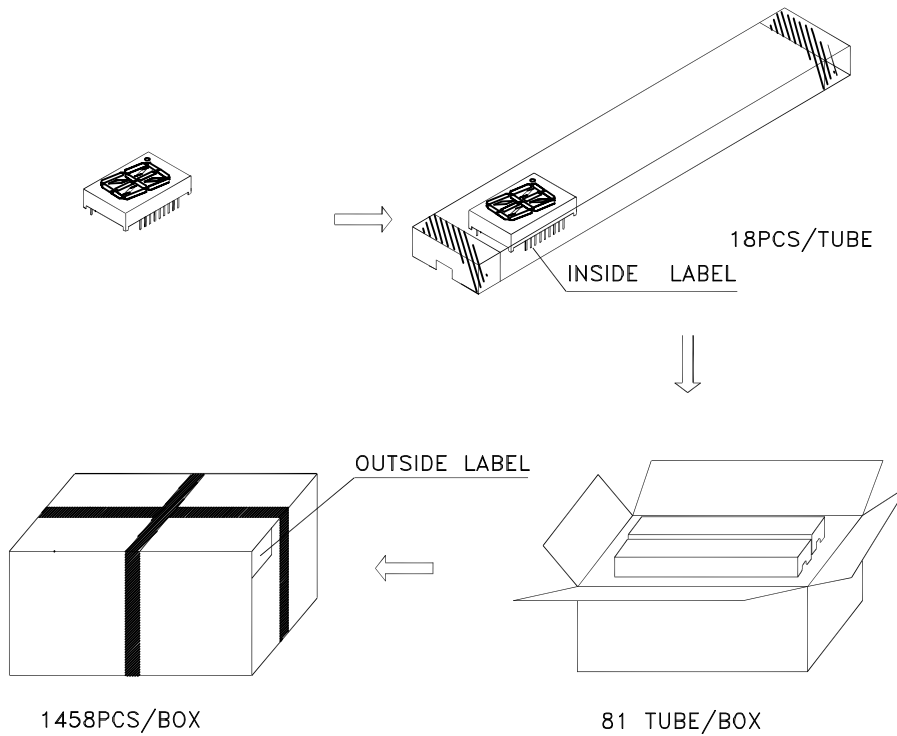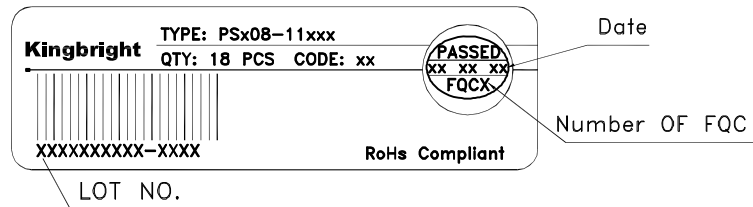1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.

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RELATIVE INTENSITY Vs. WAVELENGTH

High Efficiency Red   PSC08-11EWA

FORWARD CURRENT Vs.
FORWARD VOLTAGE

LUMINOUS INTENSITY Vs.
FORWARD CURRENT

FORWARD CURRENT
DERATING CURVE

LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

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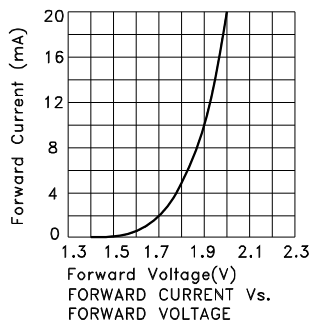
PACKING & LABEL SPECIFICATIONS   **PSC08-11EWA**

18PCS/TUBE

INSIDE   LABEL

OUTSIDE LABEL

1458PCS/BOX   81 TUBE/BOX

Inside Label On IC-tube

Kingbright   TYPE: PSx08-11xxx   PASSED   Date
             QTY: 18 PCS   CODE: xx   xx xx xx
                                                FQCX
XXXXXXXXX-XXXX   RoHs Compliant   Number OF FQC

LOT NO.

Outside Label On Box

XXXXXX

PSx08-11xxx   Bin Code   Number OF QA

1458 PCS   XX   QAx   Date
                                                xx xx xx
                                                PASSED

RoHS Compliant

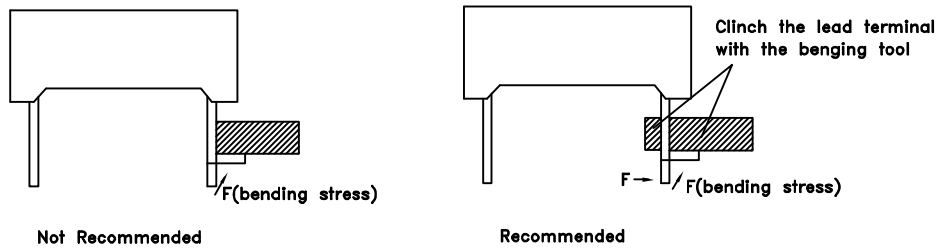# Kingbright
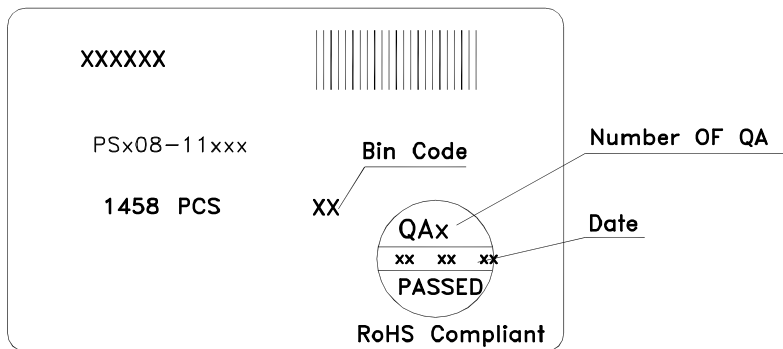
THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools.
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

Clinch the lead terminal with the benging tool

F(bending stress)

Not Recommended

F → F(bending stress)

Recommended

Installation

1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.
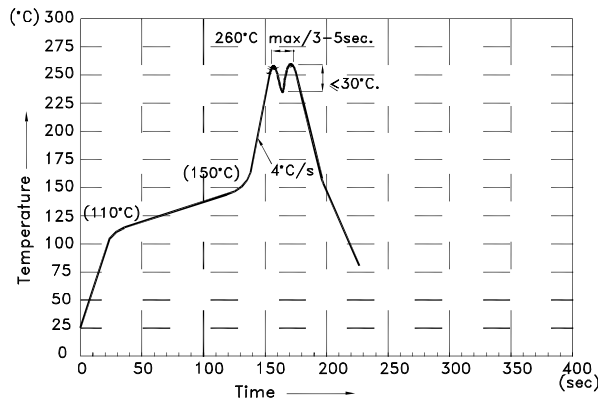
F   F

Not Recommended
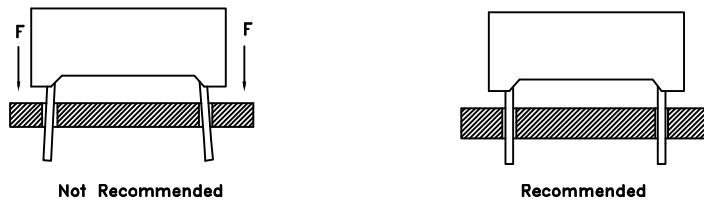
Recommended

3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.

Not Recommended

>=5mm   >=5mm

Recommended

Kingbright
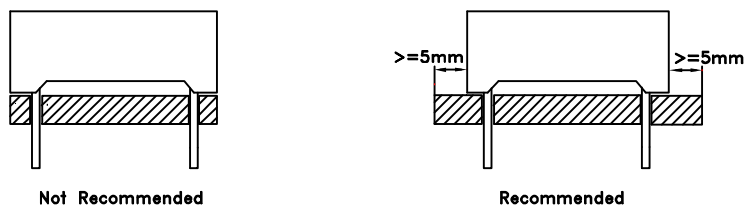
DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.

NOTES:
1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering , the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

Soldering General Notes:

1. Through-hole displays are incompatible with reflow soldering.

2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.

2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.

2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.

Recommended Set-up

invalid Set-up
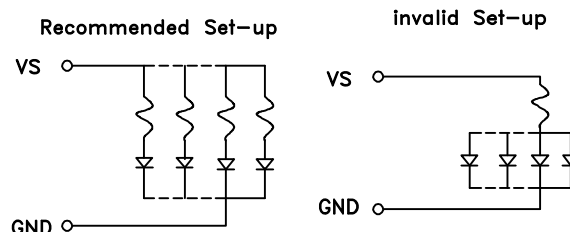
Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes